

HD74HC166 Parallel-load 8-bit Shift Register

REJ03D0582-0300 Rev.3.00 Jan 31, 2006

Description

This device is an 8-bit shift register with an output from the last stage. Data may be loaded into the register either in parallel or in serial form. When the Shift/Load input is low, the data is loaded asynchronously in parallel. When the Shift/Load input is high, the data is loaded serially on the rising edge of either clock inhibit or Clock. Clear is asynchronous and active-low.

The 2-input NOR clock may be used either by combining two independent clock sources or by designating one of the clock inputs to act as a clock inhibit.

Features

- High Speed Operation: t_{pd} (Clock to Q_H) = 14 ns typ (C_L = 50 pF)
- High Output Current: Fanout of 10 LSTTL Loads
- Wide Operating Voltage: $V_{CC} = 2 \text{ to } 6 \text{ V}$
- Low Input Current: 1 µA max
- Low Quiescent Supply Current: I_{CC} (static) = 4 μ A max (Ta = 25°C)
- Ordering Information

Part Name	Package Type	Package Code (Previous Code)	Package Abbreviation	Taping Abbreviation (Quantity)
HD74HC166P	DILP-16 pin	PRDP0016AE-B (DP-16FV)	Ρ	—
HD74HC166FPEL	SOP-16 pin (JEITA)	PRSP0016DH-B (FP-16DAV)	FP	EL (2,000 pcs/reel)

Note: Please consult the sales office for the above package availability.

Function Table

		Clock	Clock Parallel			Internal	Output	
Clear	Shift/Load	Inhibit	Clock	Serial	ΑΗ	Q _A	QB	Q _H
L	Х	Х	Х	Х	Х	L	L	L
Н	Х	L	L	Х	Х	Q _{A0}	Q _{B0}	Q _{H0}
Н	L	L		Х	a h	а	b	h
Н	Н	L		Н	Х	Н	Q _{An}	Q _{Gn}
Н	Н	L		L	Х	L	Q _{An}	Q _{Gn}
Н	Х	Н		Х	Х	Q _{A0}	Q _{B0}	Q _{H0}

 Q_{Ao} to Q_{Ho} = Outputs remain unchanged.

 Q_{An} to Q_{Gn} = Data shifted from the previous stage on a positive edge at the clock input.

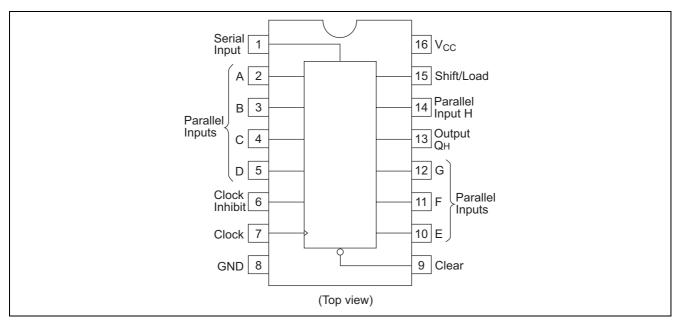
H: High level

L: Low level

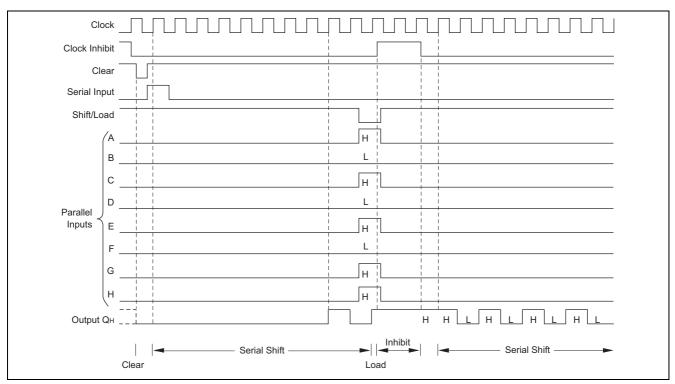
X: Irrelevant



Pin Arrangement



Timing Diagram





Absolute Maximum Ratings

ltem	Symbol	Ratings	Unit
Supply voltage range	V _{CC}	-0.5 to 7.0	V
Input / Output voltage	Vin, Vout	-0.5 to V _{CC} +0.5	V
Input / Output diode current	I _{IK} , I _{OK}	±20	mA
Output current	lo	±25	mA
V _{CC} , GND current	I _{CC} or I _{GND}	±50	mA
Power dissipation	PT	500	mW
Storage temperature	Tstg	-65 to +150	°C

Note: The absolute maximum ratings are values, which must not individually be exceeded, and furthermore, no two of which may be realized at the same time.

Recommended Operating Conditions

Item	Symbol	Ratings	Unit	Conditions
Supply voltage	V _{cc}	2 to 6	V	
Input / Output voltage	V _{IN} , V _{OUT}	0 to V _{CC}	V	
Operating temperature	Та	-40 to 85	°C	
		0 to 1000		V _{CC} = 2.0 V
Input rise / fall time ^{*1}	t _r , t _f	0 to 500	ns	$V_{CC} = 4.5 V$
		0 to 400		$V_{CC} = 6.0 V$

Note: 1. This item guarantees maximum limit when one input switches. Waveform: Refer to test circuit of switching characteristics.

Electrical Characteristics

			Т	a = 25°	С	Ta = -40 to+85°C				
Item	Symbol	V _{cc} (V)	Min	Тур	Max	Min	Max	Unit	Test Con	ditions
Input voltage	VIH	2.0	1.5		_	1.5	—	V		
		4.5	3.15		_	3.15	—			
		6.0	4.2		_	4.2	—			
	VIL	2.0	_	_	0.5	_	0.5	V		
		4.5	_	_	1.35	_	1.35			
		6.0	_	—	1.8	_	1.8			
Output voltage	V _{OH}	2.0	1.9	2.0	_	1.9	—	V	$Vin = V_{IH} \text{ or } V_{IL}$	I _{OH} = -20 μA
		4.5	4.4	4.5	_	4.4	—			
		6.0	5.9	6.0		5.9	—			
		4.5	4.18			4.13	—			$I_{OH} = -4 \text{ mA}$
		6.0	5.68		_	5.63	—			$I_{OH} = -5.2 \text{ mA}$
	V _{OL}	2.0	_	0.0	0.1	_	0.1	V	$Vin = V_{IH} \text{ or } V_{IL}$	I _{OL} = 20 μA
		4.5		0.0	0.1	_	0.1			
		6.0	_	0.0	0.1	_	0.1			
		4.5	_	_	0.26	_	0.33			$I_{OL} = 4 \text{ mA}$
		6.0	_	_	0.26		0.33			I _{OL} = 5.2 mA
Input current	lin	6.0	_	_	±0.1	—	±1.0	μA	Vin = V _{CC} or GND	
Quiescent supply current	I _{CC}	6.0	_	—	4.0	—	40	μA	$Vin = V_{CC} \text{ or } GN$	D, lout = 0 μA

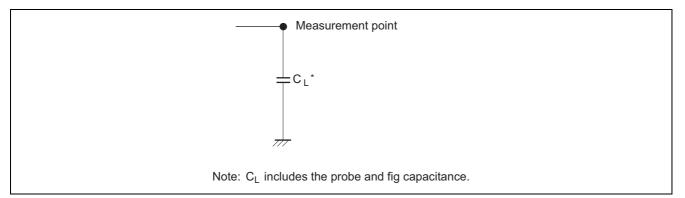
Switching Characteristics

 $(C_L = 50 \text{ pF}, \text{ Input } t_r = t_f = 6 \text{ ns})$

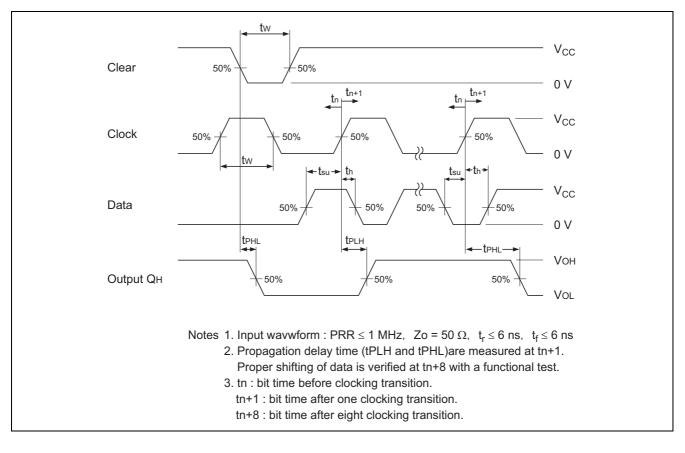
	Ta = 25°C Ta = -40 to +85°		to +85°C						
Item	Symbol	V _{cc} (V)	Min	Тур	Max	Min	Max	Unit	Test Conditions
Maximum clock	f _{max}	2.0	_	—	5	—	4	MHz	
frequency		4.5	_	_	25	—	20		
		6.0			29	_	24		
Propagation delay	t _{PHL} , t _{PLH}	2.0		—	175	—	220	ns	Clock to Q _H
time		4.5		14	35	—	44		
		6.0			30	—	37		
	t _{PHL}	2.0			150	—	190	ns	Clear to Q _H
		4.5		12	30	—	38		
		6.0		_	26	—	33		
Setup time	t _{su}	2.0	150			190	_	ns	Shift/Load to Clock
		4.5	30	2		38	—		
		6.0	26	—	_	33	_		
		2.0	100	_		125	—	ns	Data to Clock
		4.5	20	1	-	25	_		
		6.0	17	_	_	21	_		
Hold time	t _h	2.0	5	_		5	—	ns	Clock to Data
		4.5	5	0		5	_		
		6.0	5	—	_	5	_		
Pulse width	t _w	2.0	80	—	-	100	_	ns	Clock, Clear
		4.5	16	6		20	_		
		6.0	14	—	—	17			
Output rise/fall	t_{TLH}, t_{THL}	2.0			75	—	95	ns	
time		4.5		5	15	—	19		
		6.0			13	—	16]	
Input capacitance	Cin		_	5	10	—	10	pF	



Test Circuit

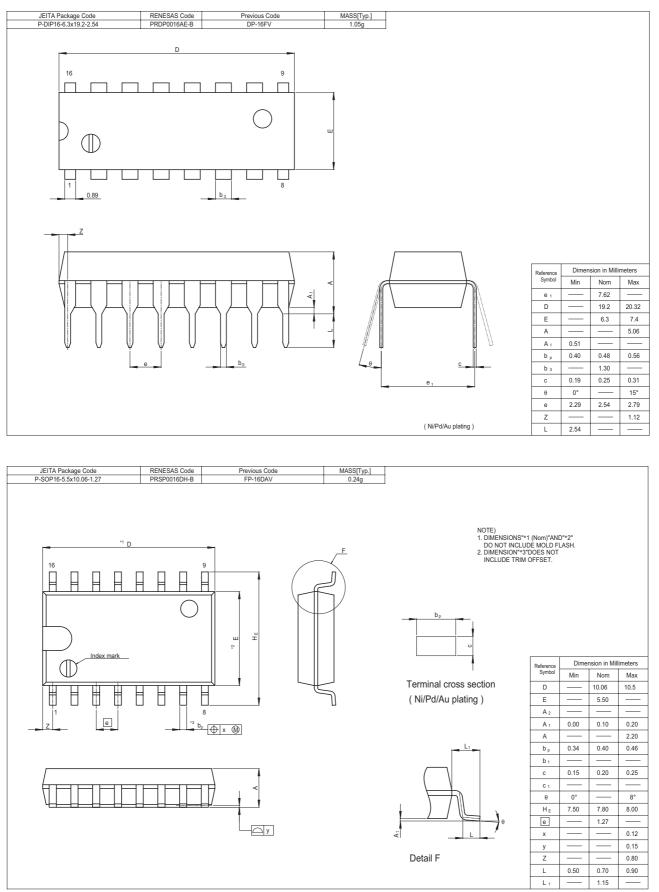


Waveforms





Package Dimensions





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